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SUM90330E

Vishay Siliconix

N-Channel 200 V (D-S) 175 °C MOSFET



| PRODUCT SUMMARY | | | | | |
|---|--------|--|--|--|--|
| V _{DS} (V) | 200 | | | | |
| $R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V | 0.0375 | | | | |
| $R_{DS(on)}$ max. (Ω) at V_GS = 7.5 V | 0.0422 | | | | |
| Q _g typ. (nC) | 21 | | | | |
| I _D (A) | 35.1 | | | | |
| Configuration | Single | | | | |

FEATURES

- ThunderFET[®] power MOSFET
- Low R_{DS} Q_g figure-of-merit (FOM)
- Maximum 175 °C junction temperature
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Synchronous rectification
- Power supplies
- DC/AC inverter
- DC/DC converter
- Solar micro inverter
- Motor drive switch

| ORDERING INFORMATION | |
|---------------------------------|---------------|
| Package | TO-263 |
| Lead (Pb)-free and halogen-free | SUM90330E-GE3 |

| ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \degree C$, unless otherwise noted) | | | | | |
|--|-------------------------|-----------------------------------|-------------------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | V _{DS} | 200 | N/ | |
| Gate-source voltage | | V _{GS} | ± 20 | V | |
| Continuous drain current | T _C = 25 °C | | 35.1 | | |
| | T _C = 125 °C | - I _D | 20.3 | | |
| Pulsed drain current (t = 100 µs) | | I _{DM} | 70 | А | |
| Continuous source-drain diode current | | I _S | 12.5 | | |
| Single pulse avalanche current ^a | | I _{AS} | 33 | | |
| Single pulse avalanche energy ^a | L = 0.1 mH | E _{AS} | 54.45 | mJ | |
| Maximum power dissipation | T _C = 25 °C | PD | 125 ^b | 14/ | |
| | T _C = 125 °C | | 41.7 ^b | W | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +175 | *0 | |
| Soldering recommendations (peak temperature) ^c | | - | 260 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|------|--|--|
| PARAMETER | | SYMBOL | MAXIMUM | UNIT | | |
| Maximum junction-to-ambient (PCB mount) ^c | | R _{thJA} | 40 | °C/W | | |
| Maximum junction-to-case (drain) | Steady state | R _{thJC} | 1.2 | 0/11 | | |

Notes

a. Duty cycle \leq 1 %

b. See SOA curve for voltage derating

c. When mounted on 1" square PCB (FR4 material)

SPending-Rev. B, 06-Sep-17

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Document Number: 74505



HALOGEN

FREE



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| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|----------------------|---|---|--------|--------|------|--|
| Static | | | | • | | 1 | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | 200 | - | - | V | |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 2 | - | 4 | V | |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | - | - | 250 | nA | |
| | | $V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | - | - | 1 | | |
| Zero gate voltage drain current | I _{DSS} | $V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | _S = 0 V, T _J = 125 °C 150 | | 150 | μA | |
| | | V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 175 °C | - | - | 5 | mA | |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 20 | - | - | Α | |
| Drain-source on-state resistance ^a | | V _{GS} = 10 V, I _D = 12.2 A | - | 0.0312 | 0.0375 | Ω | |
| | R _{DS(on)} | $V_{GS} = 7.5 \text{ V}, \text{ I}_{D} = 11.5 \text{ A}$ | - | 0.0337 | 0.0422 | | |
| Forward transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 10 A | - | 28 | - | S | |
| Dynamic ^b | | | | • | | | |
| Input capacitance | C _{iss} | | - | 1172 | - | pF | |
| Output capacitance | C _{oss} | $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$ | - | 150 | - | | |
| Reverse transfer capacitance | C _{rss} | | - | 11 | - | | |
| Total gate charge | Qg | | - | 21 | 32 | | |
| Gate-source charge | Q _{gs} | V_{DS} = 100 V, V_{GS} =10 V, I_{D} = 12.2 A | - | 6 | - | nC | |
| Gate-drain charge | Q _{gd} | | - | 5.3 | - | | |
| Gate resistance | Rg | f = 1 MHz | 0.76 | 3.8 | 7.6 | Ω | |
| Turn-on delay time | t _{d(on)} | | - | 12 | 24 | | |
| Rise time | t _r | $V_{DD} = 100 \text{ V}, \text{ R}_{L} = 14.2 \Omega, \text{ I}_{D} \cong 7 \text{ A},$ | - | 25 | 50 | | |
| Turn-off delay time | t _{d(off)} | V_{GEN} = 10 V, R_g = 1 Ω | - | 30 | 50 | ns | |
| Fall time | t _f | | - | 22 | 44 | | |
| Drain-Source Body Diode Characteristi | cs | | | • | • | | |
| Pulse diode forward current (t = 100 µs) | I _{SM} | | - | - | 70 | Α | |
| Body diode voltage | V _{SD} | I _F = 7 A, V _{GS} = 0 V | - | 0.8 | 1.5 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 111 | 170 | ns | |
| Body diode reverse recovery charge | Q _{rr} | | - | 0.51 | 1 | μC | |
| Reverse recovery fall time | t _a | I _F = 7 A, di/dt = 100 A/μs | - | 94 | - | | |
| Reverse recovery rise time | t _b | | - | 17 | - | ns | |
| Body diode peak reverse recovery charge | I _{RM(REC)} | | - | 8.5 | 17 | Α | |

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

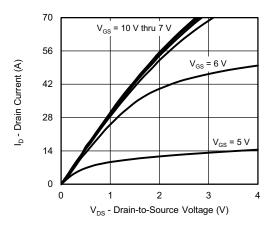
2



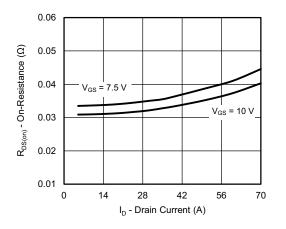
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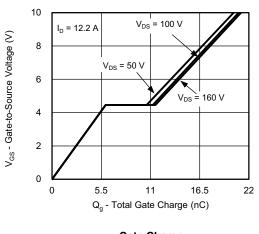
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



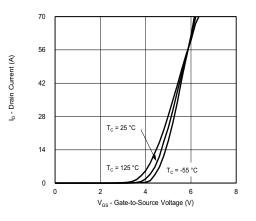
Output Characteristics



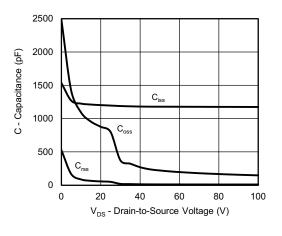
On-Resistance vs. Drain Current and Gate Voltage



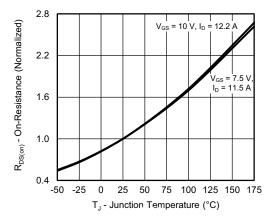
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

SPending-Rev. B, 06-Sep-17

3 For technical questions, contact: <u>pmostechsupport@vishay.com</u> Document Number: 74505

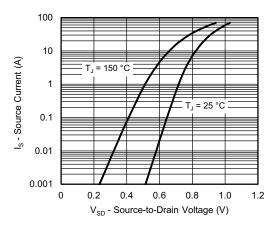
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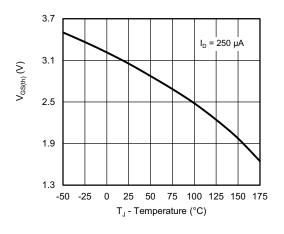
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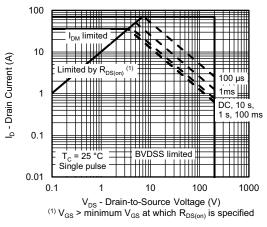
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



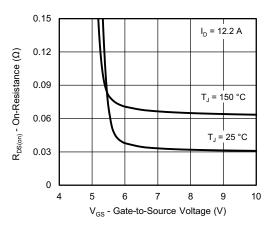
Source-Drain Diode Forward Voltage



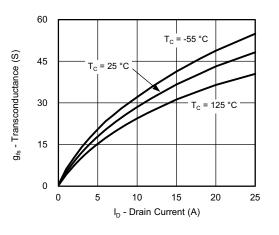
Threshold Voltage



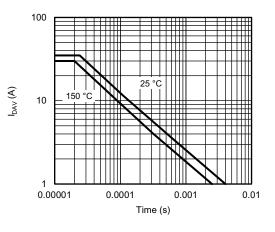
Safe Operating Area, Junction-to-Ambient



On-Resistance vs. Gate-to-Source Voltage



Transconductance



Avalanche vs. Time

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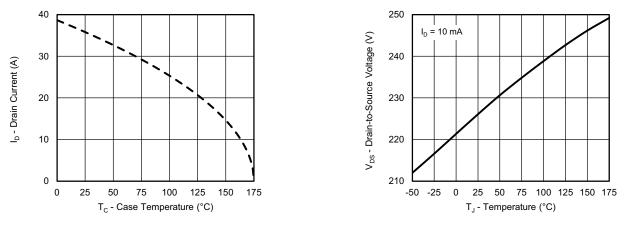
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

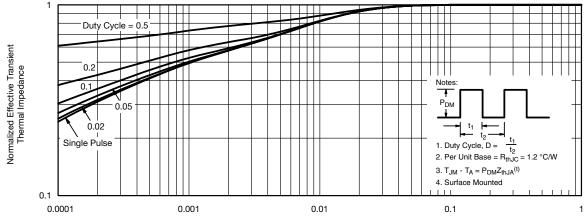


Current Derating ^a

Drain Source Breakdown vs. Junction Temperature

Note

a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



Square Wave Pulse Duration (s)

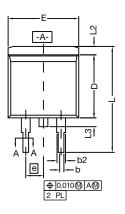
Normalized Thermal Transient Impedance, Junction-to-Case

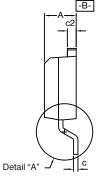
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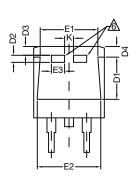


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TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



| | | INCHES | | MILLIMETERS | | |
|--|------------|-----------|-------|-------------|--------|--|
| DIM. | | MIN. | MAX. | MIN. | MAX. | |
| A | | 0.160 | 0.190 | 4.064 | 4.826 | |
| b | | 0.020 | 0.039 | 0.508 | 0.990 | |
| | b1 | 0.020 | 0.035 | 0.508 | 0.889 | |
| | b2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| с* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 | |
| С | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 | |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 | |
| CI | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 | |
| | c2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D | 0.340 | 0.380 | 8.636 | 9.652 | |
| | D1 | 0.220 | 0.240 | 5.588 | 6.096 | |
| | D2 | 0.038 | 0.042 | 0.965 | 1.067 | |
| D3 | | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D4 | 0.044 | 0.052 | 1.118 | 1.321 | |
| | E | 0.380 | 0.410 | 9.652 | 10.414 | |
| | E1 | 0.245 | - | 6.223 | - | |
| | E2 | 0.355 | 0.375 | 9.017 | 9.525 | |
| | E3 | 0.072 | 0.078 | 1.829 | 1.981 | |
| | е | 0.100 | BSC | 2.54 BSC | | |
| | К | 0.045 | 0.055 | 1.143 | 1.397 | |
| | L | 0.575 | 0.625 | 14.605 | 15.875 | |
| L1 | | 0.090 | 0.110 | 2.286 | 2.794 | |
| L2 | | 0.040 | 0.055 | 1.016 | 1.397 | |
| L3 0.05 | | 0.050 | 0.070 | 1.270 | 1.778 | |
| | L4 | 0.010 BSC | | 0.254 BSC | | |
| | M - 0. | | 0.002 | - | 0.050 | |
| ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843 | | | | | | |

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 $\,\%\,$ of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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